

Material	Dual e-Beam	Thermal e-Beam	Sputterer	PLD	Supplied by
Aluminum	X	X	X		UDNF
Aluminum Oxide	X	X	X		UDNF
Bismuth and Gallium Substituted Thulium Iron Garnet ($\text{Tm}_{2.5}\text{Bi}_{0.5}\text{Fe}_{3.8}\text{Ga}_{1.2}\text{O}_{12}$)				X	User
Bismuth and Gallium Substituted Thulium Iron Garnet ($\text{Tm}_{2.7}\text{Bi}_{0.3}\text{Fe}_{4.5}\text{Ga}_{0.5}\text{O}_{12}$)				X	User
Boron		X			User
Boron Carbide			X		User
Chromium	X	X	X		UDNF
Cobalt	X	X	X		UDNF
Cobalt/Iron 90/10		X	X		UDNF
Copper	X	X			UDNF
Gallium Oxide/Bismuth Oxide				X	User
Germanium	X	X	X		Sputterer Target by User
Gold	X	X			UDNF
Iron		X	X		UDNF
Nickel	X	X	X		UDNF
Nickel/Iron 81/19	X	X			UDNF
Palladium	X	X			UDNF
Platinum	X	X	X		UDNF
Ruthenium	X	X			UDNF

Scandium			X		User
Silicon, p-type	X	X			UDNF
Silicon Carbide			X		UDNF
Silicon Nitride			X		User
Silicon Dioxide	X	X	X		UDNF
Silver	X	X			UDNF
Tantalum	X	X			UDNF
Terbium Iron Garnet ($Tb_3Fe_5O_{12}$)				X	User
Thulium Iron Garnet ($Tm_3Fe_5O_{12}$)				X	User
Tin Oxide			X		UDNF
Titanium	X	X	X		UDNF
Titanium Oxide	X	X	X		UDNF
Tungsten			X		UDNF
Tungsten Oxide	X	X			UDNF
Vanadium Pentoxide				X	User
Vanadium pentoxide/Tungsten Dioxide				X	User
Yttrium Iron Oxide (YIG)			X	X	UDNF

Last Updated

June 7, 2021